

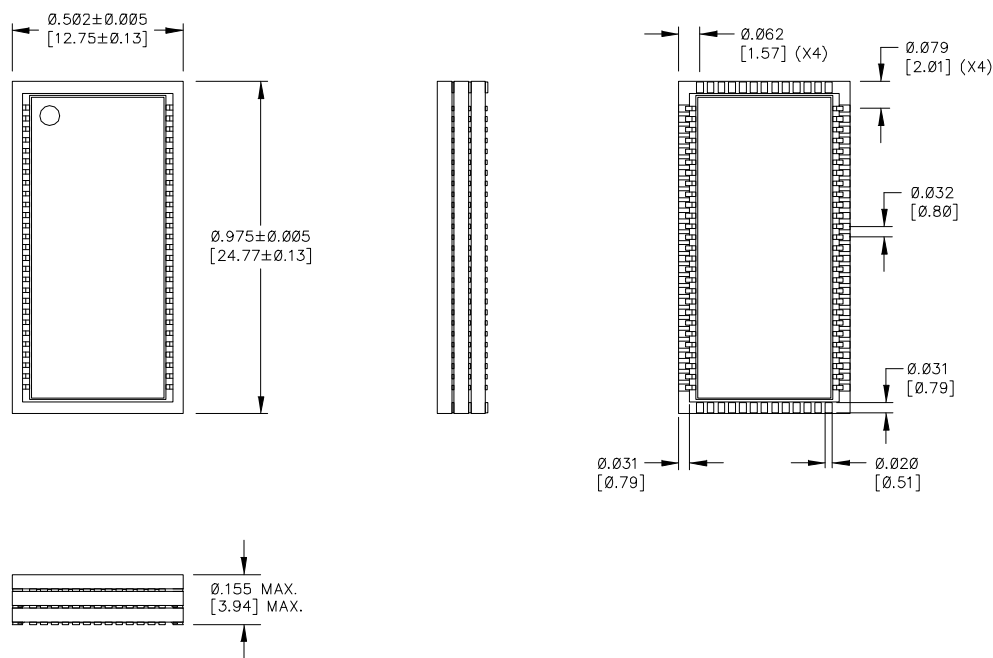
PRELIMINARY

PART NUMBER DESCRIPTION

DP	SD	4M	X	32	R	Y5	—	DP	—	XX	XX	X	X		
PREFIX	TYPE	MEMORY DEPTH	DESIG	MEMORY WIDTH	DESIG	PACKAGE		SUPPLIER		MEMORY	SPEED	CL	GRADE		
														Blank	Commercial Temperature
														I	Industrial Temperature
														M	Military Temperature
														2	CAS LATENCY 2
														15 ^[1]	15ns (66MHz) ^[1]
														12 ^[1]	12ns (83MHz) ^[1]
														10	10ns (100MHz)
														08 ^[2]	8ns (125MHz) ^[2]
														75 ^[2]	7.5ns (133MHz) ^[2]
														P1	PC100
															MANUFACTURER CODE ^[3]
															SUPPLIER CODE ^[3]
															STACKABLE TSOP
															64 MEGABIT LVTTL BASED
															MEMORY MODULE WITHOUT SUPPORT LOGIC
															SYNCHRONOUS DRAM

NOTES: [1] Available in Military and Industrial Temperature Ranges Only.
 [2] Available in Commercial Temperature Range Only.
 [3] Contact your sales representative for supplier and manufacturer codes.

MECHANICAL DRAWING



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